

Vishay Siliconix

# N-Channel 30-V (D-S) MOSFET

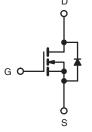
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>f</sup>	Q <sub>g</sub> (Typ.)			
30	0.006 at V <sub>GS</sub> = 10 V	35 <sup>g</sup>	13.7 nC			
	$0.0082 \text{ at V}_{GS} = 4.5 \text{ V}$	35 <sup>g</sup>	13.7 110			

## **FEATURES**

- · Halogen-free
- TrenchFET® Power MOSFET
- **PWM Optimized**
- 100 % R<sub>a</sub> Tested
- 100 % UIS Tested

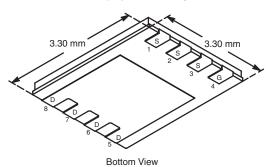
## **APPLICATIONS**

- High Side Switch
  - VRM
  - POL



N-Channel MOSFET

#### PowerPAK 1212-8



Ordering Information: Si7718DN-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		$V_{DS}$	30	V
Gate-Source Voltage		$V_{GS}$	± 20	V
	T <sub>C</sub> = 25 °C		35 <sup>g</sup>	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C	l <sub>D</sub>	35 <sup>g</sup>	
Continuous Diain Current (1) = 130 C)	T <sub>A</sub> = 25 °C	טי	18.5 <sup>a, b</sup>	
	T <sub>A</sub> = 70 °C		16.9 <sup>a, b</sup>	A
Pulsed Drain Current		I <sub>DM</sub>	70	^
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	1-	35 <sup>g</sup>	
Continuous Source-Diam Diode Current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	3.3 <sup>a, b</sup>	
Single Pulse Avalanche Current Single Pulse Avalanche Energy  L = 0.1 mH		I <sub>AS</sub>	20	
		E <sub>AS</sub>	20	mJ
	T <sub>C</sub> = 25 °C		52	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	$P_{D}$	43	W
Maximum Fower Dissipation	T <sub>A</sub> = 25 °C		3.7 <sup>a, b</sup>	v
	T <sub>A</sub> = 70 °C		3.1 <sup>a, b</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C
Soldering Recommendations (Peak Temperature) <sup>c, d</sup>			260	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, e</sup>	t ≤ 10 s	$R_{thJA}$	24	33	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	1.9	2.4		

#### Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- c. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
  d. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
  e. Maximum under steady state conditions is 81 °C/W.

- f. Based on  $T_C = 25$  °C. g. Package limited.

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<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		30		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1D = 250 μΑ		- 5			
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	1.2		2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
		$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_J$ = 55 °C			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
Drain Course On State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		0.0048	0.006	Ω	
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$		0.0065	0.0082		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A		50		S	
Dynamic <sup>b</sup>						•	
Input Capacitance	C <sub>iss</sub>			1600		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		335			
Reverse Transfer Capacitance	C <sub>rss</sub>			115			
Tatal Cata Chausa	0	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$		30	45	nC	
Total Gate Charge	Q <sub>g</sub>			13.7	21		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		4.3			
Gate-Drain Charge	$Q_{gd}$			4.3			
Gate Resistance	$R_g$	f = 1 MHz	0.3	0.75	1.5	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			22	35	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$		13	26		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ 10 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$		26	45		
Fall Time	t <sub>f</sub>			12	24		
Turn-On Delay Time	t <sub>d(on)</sub>			13	26		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$		9	18		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ 10 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		22	35		
Fall Time	t <sub>f</sub>			8	16		
<b>Drain-Source Body Diode Characteristi</b>	cs						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			35	Λ	
Pulse Diode Forward Current	I <sub>SM</sub>				70	Α	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V		0.75	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			19	35	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	L = 10 A dl/dt = 100 A/vo T = 05 °C		9.5	18	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		11			
Reverse Recovery Rise Time	t <sub>b</sub>			8		ns	

## Notes:

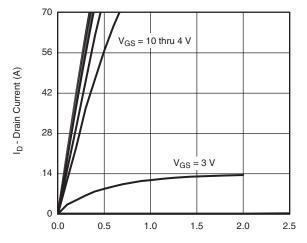
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



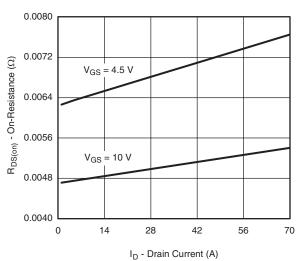
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

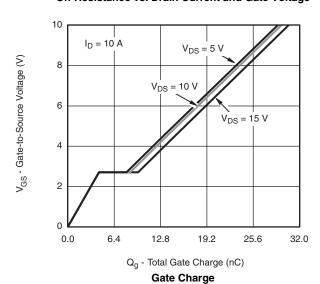


V<sub>DS</sub> - Drain-to-Source Voltage (V)

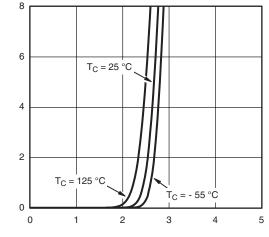
#### **Output Characteristics**



On-Resistance vs. Drain Current and Gate Voltage

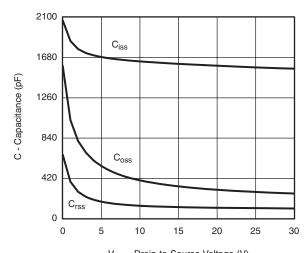


I<sub>D</sub> - Drain Current (A)



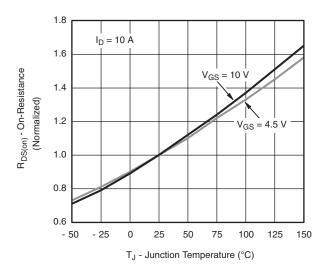
V<sub>GS</sub> - Gate-to-Source Voltage (V)

#### **Transfer Characteristics**



 $V_{\text{DS}}$  - Drain-to-Source Voltage (V)

## Capacitance



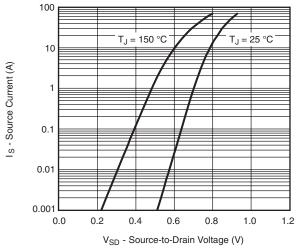
On-Resistance vs. Junction Temperature

## **Si7718DN**

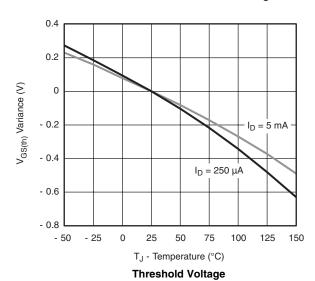
## Vishay Siliconix

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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

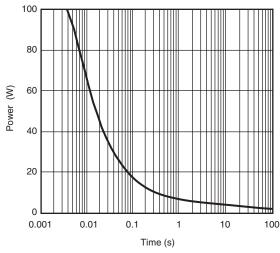


#### Source-Drain Diode Forward Voltage

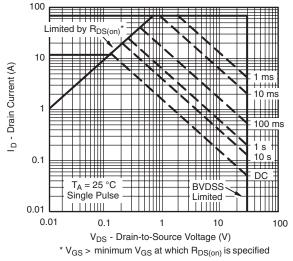


0.030
0.024
0.018
0.012
0.000
0 1 2 3 4 5 6 7 8 9 10  $V_{GS}$  - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



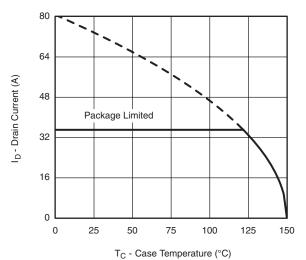
Single Pulse Power, Junction-to-Ambient



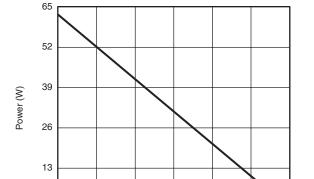


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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating\*



T<sub>C</sub> - Case Temperature (°C)

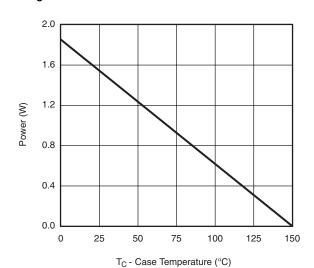
Power, Junction-to-Case

75

100

125

150



Power, Junction-to-Ambient

0

25

50

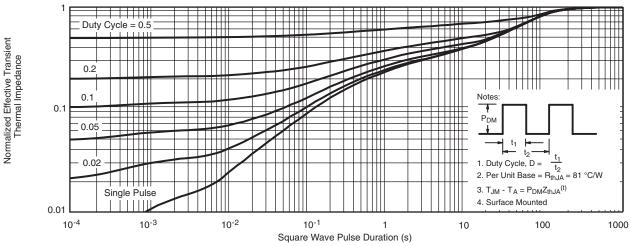
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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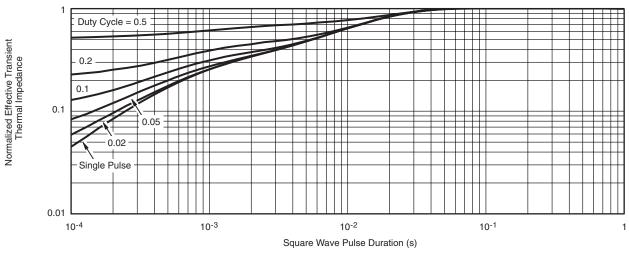
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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